

A

B

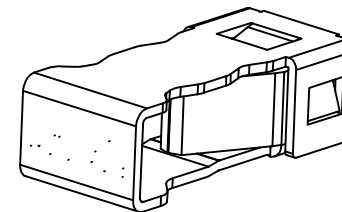
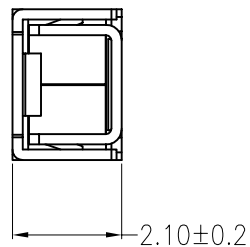
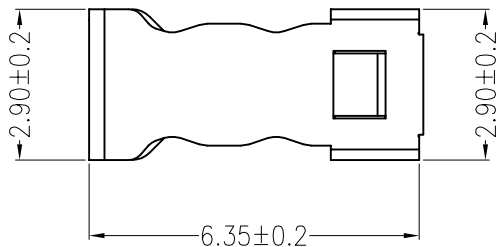
C

D

E

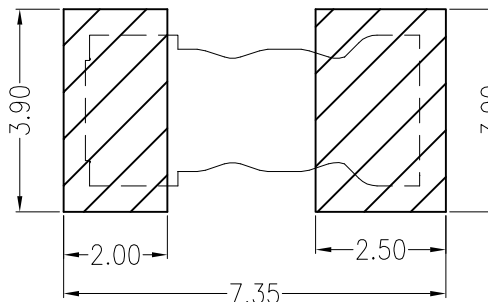
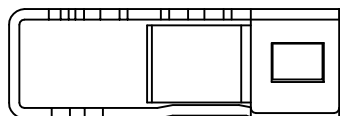
F

REV	DESCRIPTION	DESIGN	DATE
A0	Release	吴丹平	2016.04.30



主要技术参数 Main Specifications

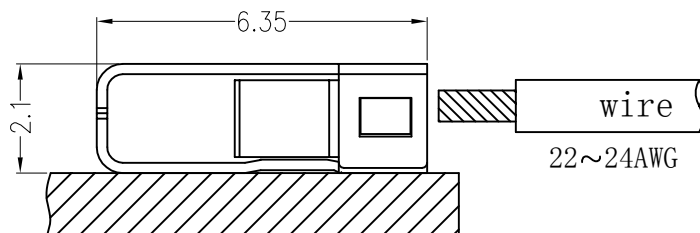
线数 (Poles): 01
 接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$
 绝缘电阻 (Insulation resistance): $\geq 800\text{M}\Omega$
 额定电压 (Rated voltage): 250 V AC DC
 额定电流 (Rated current): 2.0A AC DC
 耐电压 (Withstand Voltage): 1500V AC/minute
 温度范围 (Temperature Range): $-45^{\circ}\text{C} \sim +125^{\circ}\text{C}$



Board Layout

ORDER INFORMATION:

L024-01-T2CB-R			
PART No.			
No. FOR CIRCUITS:			PACKAGING: R=REEL P=PE
PLASTIC MATERIAL:			PLATING: B=MATTE Sn
T2C=PBR (BEIGE)			



Assembly Layout

C				
B				
A	CONTACT	1 PCS	PhosphorBronze	MATTE Sn-plated
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
广东科斯达电子科技有限公司 GUANG DONG KE SI DA ELECTRONIC TECHNOLOGY CO., LTD.				TITLE: -
X.±0.5	X.±5'	USE:	PART NO.:	
.X±0.3	.X±2'	CUSTOMER	L024-01-T2CB-R	
.XX±0.25	.XX±1'	APPD: 邵敬和	DWG NO.:	
--	--	CHKD: 田峰	GCCP-0045	
	UNITS: mm	DR: 周秀龙	SCALE	SHEET
			1 : 1	1 / 1

A

B

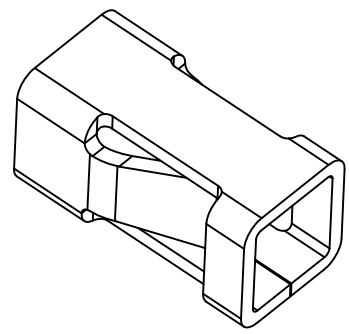
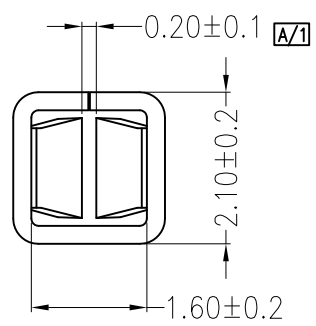
C

D

E

F

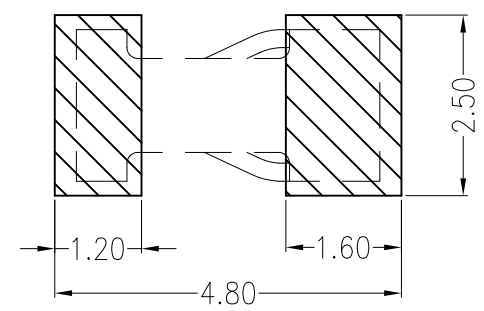
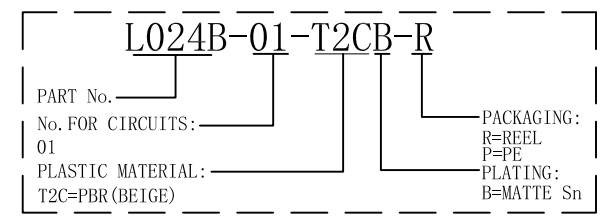
REV	DESCRIPTION	DESIGN	DATE
A0	Release	吴丹平	2016.04.30
A/1	增加管控开口尺寸	曾令青	2018.08.22



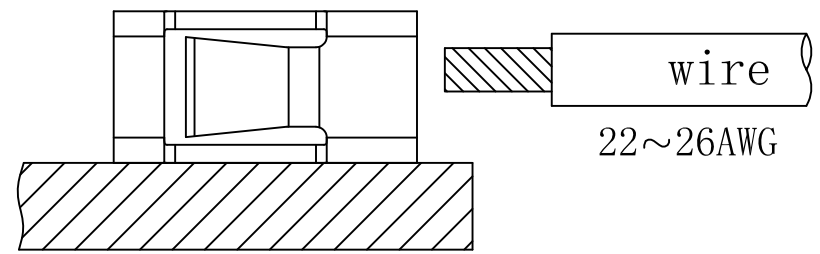
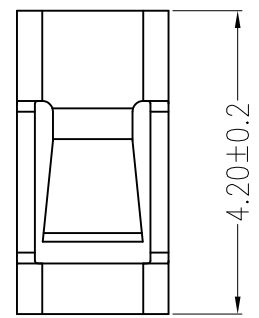
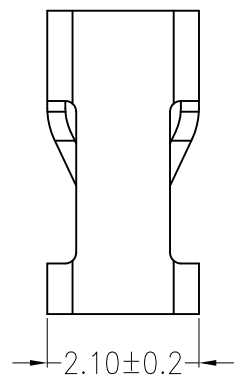
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 绝缘电阻 (Insulation resistance):
 额定电压 (Rated voltage): 250 V AC DC
 额定电流 (Rated current): 2.0A AC DC
 耐电压 (Withstand Voltage):
 温度范围 (Temperature Range):

ORDER INFORMATION:



Board Layout



Assembly Layout

ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
C				
B				
A	CONTACT	1 PCS	PhosphorBronze	MATTE Sn-plated

广东科斯达电子科技有限公司 GUANG DONG KE SI DA ELECTRONIC TECHNOLOGY CO., LTD.		TITLE: -	
X.±0.5	X.±5'	USE:	PART NO.:
.X±0.3	.X±2'	CUSTOMER	L024B-01-T2CB-R
.XX±0.25	.XX±1'	APPD: 邵敬和	DWG NO.:
--	--	CHKD: 田峰	GCCP-0301
⊕	◁	UNITS: mm	DR: 蒋建银
		SCALE	SHEET
		1 : 1	1 / 1